

Cathodes

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Overview

- QE Measurement
- Metallic Photocathodes
 - Normal Conductors (LCLS Copper)
 - Superconductors (Lead)
 - Lab tests
 - SRF Gun measurements at TJNAF
- Semiconductor Photocathodes
 - Positive Electron Affinity (K₂CsSb)
 - Deposition Systems
 - Gun tests at TJNAF
 - In-situ X-ray analysis
- Diamond Electron Amplifier
 - Amplifier tests
 - ARPES on diamond

QE Measurements





QE Measurement Notes

$$QE = \frac{\#e_{emitted}^{-}}{\#\gamma_{incident}} = h \nu \frac{I}{P}$$

Good QE measurement requires four things:

- High resolution current or charge measurement
 - Electrometer (Keithley 6517 or similar)
 - Charge sensitive preamp (pulsed measurement)
- Variable photon energy source
 - White light + Monochromator
 - Array of lasers (made more feasible with cheap diode lasers and doubled Nd:YAGs)
- Precision optical power/energy meter
 - QE measurement is only as accurate as the measurement of photons in!
- Sufficient bias to overcome space charge!
 - Always plot charge/current vs pulse energy/optical power

Metal Cathodes

Metal photocathodes are commonly used in high gradient, high frequency RF guns and are the mainstay of the BNL/SLAC/UCLA and the LCLS s-band guns. Due to the high work function UV photons are needed for reasonable QE, which makes them impractical for high average current applications such as ERLs. However, they are the most robust of all the photoemitters and can survive for years at the high cathode fields required to produce a high brightness beam. The current copper cathode in the LCLS gun has operated for the x-ray FEL for over a year.

Metal Cathodes	Wavelength & Energy: λ _{opt} (nm), ħω(eV)	Quantum Efficiency (electrons per	Vacuum for 1000 Hr Operation (Torr)	Work Function, ø _w (eV)	Thermal Emittance (microns/mm(rms))	
		photon)			Theory	Expt.
Bare Metal						
Cu	250, 4.96	1.4x10 ⁻⁴	10-9	4.6 [34]	0.5	1.0±0.1 [39]
						1.2±0.2 [40]
						0.9±0.05 [3]
Mg	266, 4.66	6.4x10 ⁻⁴	10-10	3.6 [41]	0.8	0.4±0.1 [41]
Pb	250, 4.96	6.9x10 ⁻⁴	10-9	4.0 [34]	0.8	?
Nb	250, 4.96	~2 10-5	10-10	4.38 [34]	0.6	?
Coated Metal						
CsBr:Cu	250, 4.96	7x10 ⁻³	10-9	~2.5	?	?
CsBr:Nb	250, 4.96	7x10 ⁻³	10-9	~2.5	?	?

The thermal emittances are computed using the listed photon and work function energies in eqn. on previous slide and expresses the thermal emittance as the normalized rms emittance in microns per rms laser size in mm. The known experimental emittances are given with references.

D. H. Dowell, I. Bazarov, B. Dunham, K. Harkay,

C. Hernandez-Garcia, R. Legg, H. Padmore, T. Rao, J. Smedley and W. Wan, NIM A622(2010)685-697.

Clean Metal Surfaces

- We like metals because they are easy
 - They are not as sensitive to vacuum
 - The support high fields (low dark emission)
 - They do not risk compromising the cavity
- However, all is not roses...
 - As we saw earlier, surface adsorbates can change (typically raise) the surface dipole and the workfunction
 - To mitigate this, metal cathodes typically have to be cleaned
 - There are three ways to do this:
 - Heat treatment
 - Laser Cleaning
 - Ion cleaning
 - Typically laser cleaning is the most practical in a gun, however care must be taken to avoid damage
 - It *does not* always pay to use the drive laser

Survivability and Lifetime: Cathode Contamination

Three sources of cathode contamination

•Residual contaminants left by fabrication, handling and storage : •Contamination and damage by the gun RF and laser

- •Ambient vacuum
- •Operating vacuum
- •Cathode cleaning,

•Contamination during operation due to molecular cracking:

- By the laser
- •By the electron beam

Profile Monitor YAGS: IN20:241 17-Dec-2009 19:42:49

Profile Monitor YAGS:IN20:241 18-Jul-2008 19:03:43



Electron beam emission image of the cathode after >1 year of operation. The UV laser beam has left a QE hole at its location.

x (mm)

-10

For LCLS contamination by molecular cracking (?) is problematic.

8

Optimum Energy Density for Cleaning

- Two lasers:
 - 266 nm, 35 ps laser (YAG, 4th harmonic, with saturatable absorber)
 - 248 nm, 5 ns laser (KrF excimer)

Metal	Energy Density of		
	Cleaning Laser		
	(mJ/mm^2)		
Copper	1		
Magnesium	0.1		
Niobium	0.6		
Lead	0.2		

- Not much difference; damage slightly more likely with ps lasers
- Typically raster scan laser to get more uniform coverage
- Some improvement from cw lamp sources
- Systematic investigation of mechanism needed
 - Chemical desorption (should only depend on $\hbar\omega$)
 - Thermal desorption (Should depend on energy deposited, ω, and timescale/cooling)



Before, x500





Before, x20k



After, x500

1.3 mJ/mm²

After, x20k

LCLS Copper Cathodes



D. H. Dowell et al., Phys. Rev. ST Accel. Beams 9, 063502 (2006)

Ion cleaning and QE measurements







ace and Materials Science

Measurements show even exposure to N_2 +0.5ppm H_2 O reduces QE, an additional hour in air reduces the QE another factor of ~500





Comparison of heat cleaning and cleaning with Ar-Ions

X-ray Photo-electron Spectroscopy (XPS) gives the surface coverage of contaminants





Atomic Force Microscope (AFM) measurement of a hand-polished sample

Cross Section - [SN2B.IMG] Z: 101.50 nm X: 50.00 µm : 50.00 µm Z: 102.28 nm X: 50.00 µm Y: 50.00 µm 68.34nm 56.62nm-44.90nm-33.18nm-21.46nm-9.74nm-8.83µm 17.65µm 35.31µm 0.00µm 26.48µm 44.14µm

AFM measurements show diamond-turned samples have grating-like ridges

Ar-Ion cleaning preferentially mills out particular grains (single crystals), producing high-contrast canyons in the surface



QE vs Ion Dose



Ion Cleaning Conclusions

•H-ion cleaning is reproducible and robust in lab experiments, but disappointing in gun tests

•Even copper cathodes are sensitive to contamination

•QE dies a factor of ~500 with 1 hour exposure to air

•Ar-ions and 230degC baking also clean but, •Ar-ions can erode the surface leading to high dark current

•Baking can re-contaminate and is less effective at removing carbon

•Some combination of H-ion and baking maybe best

•Current LCLS cathode process is laser cleaning



Putting the Cathode in the Gun







Contiguous black planes or plugs

Plugs are convenient, but the joint provides field enhancement and RF breakdown at high field

Mg is friction welded into copper



Superconducting Photocathodes

- The cathode-cavity interface is the most difficult part a superconducting injector
- Using a superconductor as a cathode removes the need for a RF choke, and may allow higher gradients
- Niobium is a poor photocathode -> use Lead
- Two ½ cell cavities (1.3 & 1.42 GHz) have been tested
 - Both reached 40 MV/m; RF performance unaffected by lead
 - 1.6 Cell reached 46 MV/m with lead
 - Lead cathode QE comparable to room temperature values
 - Peak laser power of 3 MW/cm² (@ 248 nm) did not quench the cavity
 - J. Smedley, T. Rao, and Q. Zhao, J. Applied Physics 98, 043111 (2005)
 - J. Sekutowicz, et al.; Phys. Rev. ST Accel. Beams, 8, 010701 (2005)
 - J. Smedley, T. Rao , J. Sekutowicz, Phys. Rev. ST Accel. Beams 11, 013502 (2008)
 - J. Smedley et al., PAC07, 1365; J. Sekutowicz et al., PAC07, 962

Cathode Preparation - Niobium

- Amorphous, RRR 250 Nb Cathodes used
- Three surface preparations:
 - Mechanical polish (with diamond slurry)
 - Electropolishing
 - Buffered chemical polish
- In situ laser cleaning
 - Nd:YAG 4th harmonic (266 nm), 12 ps pulse, ~0.2 mJ/mm²
 - KrF Excimer (248 nm), 12 ns pulse, ~2 mJ/mm²

Nb Surface Finish

Buffered Chemical Polish







no laser cleaning

0.25 mJ/mm² 12 ps Nd:YAG (266 nm) 0.67 mJ/mm² 12 ps Nd:YAG (266nm)

20 µm

Laser Cleaning on Niobium

Cleaning with 12ps Nd: YAG (266 nm)



Cathode Preparation - Lead

- Nb Cathodes used as substrate
- Four deposition methods:
 - Electroplating
 - Vacuum deposition (evaporation)
 - Sputtering
 - Vacuum Arc deposition
- Solid lead, mechanically polished
- In situ laser cleaning

– KrF Excimer (248 nm), 12 ns pulse, ~0.2 mJ/mm²

DC Room Temperature Photoemission Results



J. Smedley, T. Rao , J. Sekutowicz Phys. Rev. ST Accel. Beams 11, 013502 (2008)

Sputtered Lead



Arc Plating of DESY Cavity Cathode Area

Coating technique and apparatus built at INS





1 – cathode, 2 – anode, 3 – focusing coil, 4 – filter inlet, 5 – filter exit, 6 – high-current cable, 7 – ion collector position, 8 – plasma stream.







Location of the heater with lead stub for plasma formation

Lead Surface Finish and Damage Threshold

Electroplated Lead



Prior to Laser Cleaning



0.11 mJ/mm²



0.26 mJ/mm²



0.52 mJ/mm²



1.1 mJ/mm²



1.8 mJ/mm²

Surface Uniformity





10 µm

All cathodes laser cleaned with 0.2 mJ/mm² of 248nm light

Solid

Cold Temperature QE

Previous measurements made at room temperature How will lead behave at cryogenic temperatures?

To find out, we mounted the cathode on a LN_2 cooled vacuum cold finger, capable of reaching -170 C

Electroplated and Arc Deposited

Structurally, the lead coatings were unaffected by multiple warm/cold cycles



Effect of Temperature and Vacuum on QE


Hybrid Cavity Options

Plug Gun (Jlab)

1.42 GHz niobium cavity w/ removable plug

DESY Gun

1.3 GHz niobium cavity $Q_0 = 1 \times 10^{10}$ w/o Lead Plating





1.6-Cell DESY Gun Cavity with Pb Test No 8 on December 8th, 2008



Vertical Test Area at Jlab

RF Sources for 0.7-2 GHz Cool to 2K in 8 hrs

Cavity cleaning and preparation

Space in radiation shield *extremely* limited





Optical Layout in Shield

Laser Parameters 248 nm (5 eV) 6 mJ/pulse 5.3 ns FWHM 150 Hz (20-250) Not synchronized Layout 6 m transport

2.7 m in cryostat

1.5 m lens

1:1 imaging of iris

3 mJ/pulse on cathode w/iris open



DC QE Measurements in VTA

Previous measurements made at room temperature How will lead behave at cryogenic temperatures?

- 1 kV bias on anode, 1 mm spacing
- Arc-deposited Lead on Niobium, deposited at same time as cavity
- Current measured leaving cathode
- Cathode laser cleaned in situ
- Laser transport same as for RF test



DC Quantum Efficiency of Arc Deposited Lead Cathode (1 MV/m field)



DC Lead Cathode



Charge Measurement



Laser Window

Cavity and beam pipe are electrically isolated

Current measured leaving cavity

1 kV DC bias on beam tube to retard secondary emission

Laser pulse duration = 5.3 ns

Many RF cycles illuminated – need to model electron escape from cavity as a function of launch phase

> ASTRA simulation finds this factor to be 3.7 for DESY cavity and 3.9 for Plug cavity for fields >0.5 MV/m

DESY Cavity, Arc-Dep Cathode



Jlab Plug Cavity QE



Exit-up cavity orientation



Linearity of Photocurrent

1.46 MV/m



Comparison to Room Temp DC



Position Scan



Electroplated Plug Quench Test

- Irradiate Nb wall with full laser energy

 Nb, because this energy might evaporate Pb w/ field on
- 1 mJ (2.9x3 mm²) & 2.9 mJ (4x5 mm²) per pulse
- Vary repetition rate, observe Q change
- Q drops ~20-30%, no evidence of quench
- No strong dependence on repetition rate
- Cooper pairs recovering between shots
- From theory, we expect this recovery time to be ~1 μs
- Good news for 1 MHz operation at ~3µJ/pulse

Coated Metal Cathodes

Quantum efficiency(%) at 257nm of CsBr/Cu sample as deposited and after exposure to air for 1 minute and pumped down to low pressure without bake out.



J. Maldonado et al., "A Robust CsBr/Cu photocathode for the LINAC COHERENT LIGHT SOURCE (LCLS)", Phys. Rev. ST Accel. Beams 11, 060702 (2008) Depositing a thin layer of CsBr increases Nb QE a factor of 350! Possibility of a superconducting cathode as thin layer maintains super conductivity of Nb-substrate.



Electrons/photon

J. Maldonado et al., "Performance of a CsBr coated Nb photocathode at room temperature", JAP 107, 013106 (2010).

Robust CsBr/Cu photocathodes for the linac coherent light source

Juan R. Maldonado,¹ Zhi Liu,² D. H. Dowell,² Robert E. Kirby,² Yun Sun,² Piero Pianetta,² and Fabian Pease¹



20 nm coating of CsBr increases cathode QE by x50
Brief atmospheric exposure OK!
4.8 eV photon – less than CsBr band gap of 7.3 eV
Two excitation mechanisms – Electron injection from Cu into CsBr conduction band Exciation of intraband states

Semiconductor Photocathodes

The primary path to high average current in photoinjectors However:

The good points:

Require UHV (<0.1 nTorr)

- QE can be >10%
- Many use visible light
 Response time
- Limited Lifetime
- Polarized cathodes possible Complicated

Common types:

 $Cs_2Te - QE \sim 7\%$ @ 262 nm, Lifetime 100's of hrs K₂CsSb – QE >4% @ 532 nm, Lifetime <10 hrs Cs:GaAs – QE ~0.5% @ 800 nm (polarized), 6% @ 527 nm

W.E. Spicer & A. Herrera-Gomez, Modern Theory and Applications of Photocathodes, SLAC-PUB-6306 (1993)

K₂CsSb (Alkali Antimonides)

- Work function 1.9eV, E_g = 1.2 eV
- Very high QE for visible light (4% -12% @ 532 nm, >30% @ 355nm)
 - Band Gap eliminates e-e scattering for hv<2E_g
 - Narrow antimony valence band limits unproductive absorption
- Deposited in 10⁻¹¹ Torr vacuum
 - Typically sequential (Sb->K->Cs); Cs deposition used to optimize QE Surface oxidation to create Cs-O dipole
 - Co-deposition increases performance in tubes
- Cathodes stable in deposition systems (after initial cooldown)
- Typical lifetime in an RF injector is measured in hours
 - Chemical poisoning is major cause of QE loss
 - Improved vacuum should help (DC/Superconducting injectors)

D. H. Dowell *et al.*, *Appl. Phys. Lett.*, **63**, 2035 (1993)C. Ghosh and B.P. Varma, *J. Appl. Phys.*, **49**, 4549 (1978)

Deposition System



Sb K Cs

Sequential deposition with retractable sources (prevents cross-contamination) Cathode mounted on rotatable linear-motion arm Typical vacuum 0.02 nTorr (0.1 nTorr during Sb deposition)

Alkali Antominide Growth









Basic Recipe for Photocathode Production

1.) Optically polished Mo substrate heat cleansed at 600° C for 30 min

2.) 50 Å Sb evaporated from effusion cell while substrate is at 160° C

3.) K and Cs evaporated sequentially from de-alloying sources (Bi-Cs and Bi-K) while substrate is at temperatures lower then 160° C. Evaporation continues as needed until maximum QE is achieved in each case.

Different recipes (temps, order) are observed produce similar results

Substrate





Cathode



Entire Deposition

■Sb ■K ■Cs ■Quantum Efficiency [%]



Typical recipe:

Molybdenum or Stainless Steel Substrate Evaporate 200 Å layer of Sb with substrate 150-190 C Evaporate K at 140 C Evaporate Cs at 120-135 C, while monitoring QE at 532 nm Cathode QE at 532 nm is 6%, but falls to 4.5% during cool Total time is ~1hr



Temperature Dependence



Substrate Dependence



X-ray Fluorescence on Sb films



- Use EDX spectroscopy in SEM
 - Measure Sb thickness
 - Spatial uniformity
- For room temperature evaporation, Sb sticks to all 3
- At 150 C, Sb film on Mo and SS very non-uniform, and not as thick as the FTM would suggest



X-ray Diffraction – Sb on Mo and Cu

- Sb on Mo at 150 C shows powder texture
- At RT, there is a pronounced [003] surface normal
- For Copper substrate at 150 C – no Sb or Cu peaks -> forming an alloy!
- Perhaps this is why the QE is always low on Copper substrates...



K₂CsSb: A cathode with excellent characteristics for accelerator applications



Performance and Robustness of K₂CsSb at 532 nm



Performance:

When illuminated with a 100 μ m focused laser, a current density of 100 mA/cm² was maintained over several days

Damage to cathode has been observed from UV radiation however none seen so far at 532

Robustness:

QE vs time at 5e-9 torr pp H20

- 50% decay time of around 17 h
- Stable to relatively high partial pressures of water
- pp in DC, RF and SRF photo-guns is better than this

Known to be stable over months when stored in UHV. However, robustness may be dependent on the details of the deposition

Setup for Measurement of Transverse Momentum

Electrons accelerated in a high gradient field, 0.4 - 3 MV/m Anode is a mesh grid, 25 µm mesh pitch Laser focused onto cathode at 30° through grid, 543 nm typical Laser spot size is ~ 200 µm FWHM Imaging done on a phosphor screen Imaged by a lens coupled CCD camera using msec exposure times Instrumental resolution is less than kT System tested and calibrated on metals, Sb and Mo



- g = cathode to grid (anode) gap, 5 mm
- d = drift distance, 252 mm
- V = applied voltage, varied from 2 kV 15 kV

Diagram of the "Momentatron"



Various Transverse Momentum Measurements on K₂CsSb



Transverse Momentum Measurement on K₂CsSb at 543 nm



 ϵ = 0.36 micron / mm rms beam size

Emittance Growth due to Cathode Thickness

Thin Cathode (smooth)



 ϵ_{405} = 0.70 µm / mm

 $\epsilon_{593} = 0.33 \ \mu m \ / \ mm$

 $\epsilon_{653} = 0.28 \ \mu m \ / \ mm$



 E_{405} = 0.89 µm / mm

Thick Cathode (rough)

 $E_{532} = 0.57 \ \mu m \ / \ mm$ $E_{593} = 0.48 \ \mu m \ / \ mm$

Note: the unit "/ mm" implies per mm RMS beam size






Jlab 200 kV DC Gun



QE map at 532 nm



- Ran 1 mA beam using 532nm light with 350 μm laser spot size

QE map at 440 nm

QE (%) MAX:4.820 MIN:0.009



440 nm (~850micron spot size)

(Lack of) QE decay at 440 nm



...and the QE improved!







- Lifetime at 20 mA increases with larger laser spot – probably a heating effect
- Test ongoing with a new cathode



Deposition with In Situ Analysis



UHV system w/ Load Lock Sb Line Source (evaporation) Sb Sputtering K and Cs Alvasources SAES Getter Sources Heat Cathode to 800C Gas cooling QE Measurement with 532 nm Residual Gas Analyzer, Quartz FTM

In-Situ Diagnostics (during growth): Pilatus 100k X-ray camera XRD for grain size and orientation in plane and reflection geometry X-ray fluorescence for stoichiometry and contamination Reflection high energy electron diffraction



Evaporation

Raw X-ray Image FT giving film thickness (nm)

450

450

450

450

450

500

500

500

500



Pilatus 100k detector 4 degrees from normal Grazing incidence X-rays

Interference between the top surface and bottom surface reflection

Fourier transform provides film thickness during deposition

SEM measurements gave a final film thickness of 39 nm (compared to 37 nm from XRR)



K-growth on Sb: One Example



Currently in progress: More quantitative analysis and systematic recipe variations

In Situ X-ray Diffraction (XRD) - Substrate

































42 nm final film thickness Onset of crystalline structure ~8nm

In Situ XRD – High Temperature Sb Sputter



In Situ XRD – Room Temperature Sb Sputter



In Situ XRD – Alkali Evaporation



In Situ X-ray Diffraction (XRD)



- High indexed reflections disappear:
 - Indication that crystallite gets smaller or very strained
- Main reflections show reduced intensity
 - Smaller crystals but still Sbphase present
- Strong background observable:
 - Not clear which Cs_xK_ySb_nphases are produced
 - Is active cathode material in amorphous phase?

XPS in-situ on cathode growth at CFN





- Used to optimize heat treatment of air-exposed Sb film
- Initially Sb and Sb-O
 - 200C does nothing
 - 400C removes most of oxide
 - 600C desorbs Sb, exposes Si Substrate



XPS in-situ on cathode growth at CFN



Deposition System for 704 MHz gun



Sb films deposited Alkali sources mounted Cathodes coming soon!



The Boeing Gun: Still the Demonstrated State-of-the Art



Material Courtesy David Dowell and John Adamski

AMMT - ERL W/S - 03/05 - 7

D. H. Dowell et al., Appl. Phys. Lett., 63, 2035 (1993)

Bialkali Photocathodes in Boeing Gun

D. Dowell et al. Nucl. Inst. Meth. 356 (2-3), 167-176 (1995).

Thin Film

Monitor

2 meter

Cathode Stick

 \sim

RGA Head

 N_2

Inlet/

Outlet

433 MHz RF Gun 26 MV/m F Field 53 psec pulse length (long pulses) 132 A peak current (high current density) 3-5 mm FWHM cathode spot size up to 7 nC / pulse macro rate 30 Hz / micro rate 27 MHz 25% duty factor



Current record holder? – 14% QE w/ green laser

Connection

to Gun

Cavity

Vacuum

Valve

Sb, K, Cs

Sources

OE Measurement Laser (GreNe)

Cs₂Te

- Most common cathode for ~1mA injectors
- Work function 3.6eV, E_g = 3.2 eV
- Good QE for UV light (Max >20%, Average ~7% @ 262 nm) Deposited in 10⁻¹¹ Torr vacuum
 - Typically sequential (Te->Cs); Cs deposition used to optimize QE
 - Co-deposition increases performance
- Typical lifetime in an RF injector is measured in weeks-months Chemical poisoning (and Cs loss?) is major cause of QE loss Improve vacuum should help (DC/Superconducting injectors) Can be shipped in vacuum suitcase
 - G. Suberlucq, EPAC04, 64
 - F. Banfi et al., FEL07, 572

Spectral Response



D. Sertore *et al.*, PAC07, 2760

Lifetime in RF gun FLASH/INFN-LASA



S. Lederer et al., EPAC08, 232

XPS of Cs₂Te



S. Lederer et al., FEL07, 457

Semiconductor Cathodes

The thermal emittances are computed using the listed photon, gap and electron affinity energies and expresses the thermal emittance as the normalized rms emittance in microns per rms laser size in mm.

Cathode Type	Cathode	Typical Wavelength, λ _{opt} (nm), (eV)	Quantum Efficiency (electrons per photon)	Vacuum for 1000 Hrs (Torr)	Gap Energy + Electron Affinity, $E_A + E_G$ (eV)	Thermal Emittance (microns/mm(rms))	
						Theory	Expt.
PEA: Mono-alkali	Cs ₂ Te	211, 5.88	~0.1	10-9	3.5 [42]	1.2	0.5±0.1 [35]
		264, 4.70	-	-	"	0.9	0.7±0.1 [35]
		262, 4.73	-	-	"	0.9	1.2 ±0.1 [43]
	Cs ₃ Sb	432, 2.87	0.15	?	1.6+0.45 [42]	0.7	?
	K ₃ Sb	400, 3.10	0.07	?	1.1 + 1.6 [42]	0.5	?
	Na ₃ Sb	330, 3.76	0.02	?	1.1 + 2.44 [42]	0.4	?
	Li ₃ Sb	295, 4.20	0.0001	?	?	?	?
PEA: Multi-alkali	Na ₂ KSb	330, 3.76	0.1	10-10	1+1 [42]	1.1	?
	(Cs)Na ₃ KSb	390, 3.18	0.2	10-10	1+0.55 [42]	1.5	?
	K ₂ CsSb	543, 2.28	0.1	10-10	1+1.1 [42]	0.4	?
	K ₂ CsSb(O)	543, 2.28	0.1	10-10	1+<1.1 [42]	~0.4	?
NEA	GaAs(Cs,F)	532, 2.33	~0.1	?	1.4±0.1 [42]	0.8	0.44±0.01 [44]
		860, 1.44	-	?	"	0.2	0.22±0.01 [44]
	GaN(Cs)	260, 4.77	-	?	1.96 + ? [44]	1.35	1.35±0.1 [45]
	GaAs(1-x)Px x~0.45 (Cs,F)	532, 2.33	-	?	1.96+? [44]	0.49	0.44±0.1 [44]
S-1	Ag-O-Cs	900, 1.38	0.01	?	0.7 [42]	0.7	?



Advantages

Secondary current can be >300x primary current Diamond acts as vacuum barrier e⁻ thermalize to near conduction-band minimum

Diamond Amplifier Setup



Diamond Amplifier Results





Demonstrated emission and gain of >100 for 7 keV primaries

Emitting ~60% of secondaries

X-ray photons have been used to generate current densities in excess of 20A/cm² with no deviation from response linearity

X. Chang et al., Phys. Rev. Lett. **105**, 164801 (2010) J. Bohon, E. Muller and J. Smedley, J. Synchrotron Rad. **17**, 711-718 (2010)

Why Does Diamond Emit?

Projection of k-space onto [100] Surface



This is the crux of the problem for NEA Diamond

Angle-Resolved Photoemission Spectroscopy




Synchrotron Measurement of B-Doped Diamond



- Photon Energy 16 eV (p-polarized)
- -10 V Bias between sample and ground
- Fermi Edge Detected (Au referenced) Past Metal-Insulator Transition (barely)
- Typical features associated with NEA (LE peak...)

6 eV Laser ARPES



- E_F located at 1.662 eV according to Au reference!
- Very efficient process (scan is short, slits are SMALL)
- KE scale referenced to E_{vac} for NEA material

J. D. Rameau, et al., Phys. Rev. Lett. **106**, 137602 (2011)

EDC at Normal Emission



- Narrow cut around normal emission
- Gaussian fits for all peaks
- No Background (e.g. from A_{inc}, "bad" secondaries)
- Angular spread ~15 degrees

Excitation in the Bulk

Emission at the Surface



Optical Phonon Spectrum



FIG. 2. Phonon dispersion curves for diamond. The open circles and dashes correspond to fits δ_1 and δ_4 in Table I. The solid circles are experimental data from Ref. 14.

E.O. Kane PRB 31, 7865 (1984)

Summary

Lead is an attractive option for medium current injectors with high bunch charge. The deposition of lead can be accomplished without compromising the RF performance of the cavity

- Alkali Antimonides represent an interesting and fruitful path toward even higher currents. In-situ characterization will hopefully lead to higher QE, longer lifetime, and *less cooking!*
- The diamond amplifier may provide a path to reaching ampere level average current. Many challenges await.

Thanks!

D. Dowell; P. Knesiel, M. Poelker, J. McCarter, R. Mammai; J. Sekutowicz; R. Nietubyc; H. Padmore, T. Vecchione; K. Attenkofer, S. Lee; I. Ben-Zvi, T. Rao, E. Muller, X. Chang, J. Rameau, J. Bohon and my colleagues at BNL;